



2814
PATENT

Case Docket No. ASMMC.033AUS

Date: April 28, 2003

Page 1

In re application of : Kim et al.)
App. No. : 10/007,304)
Filed : December 5, 2001)
For : COPPER INTERCONNECT)
STRUCTURE HAVING)
STUFFED DIFFUSION)
BARRIER)
Examiner : RAO)
Art Unit : 2814)

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April 28, 2003

(Date)

Andrew N. Merickel, Reg. No. 53,317

TECHNOLOGY CENTER 2800

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UNITED STATES PATENT AND TRADEMARK OFFICE
P.O. Box 2327
Arlington, VA 22202

Sir:

Transmitted herewith is an amendment in the above-identified application.

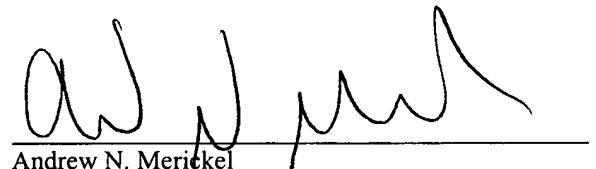
The fee has been calculated as shown below:

CLAIMS AS FILED

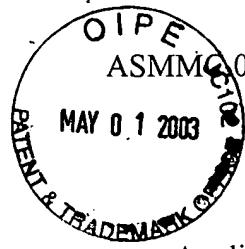
CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims 58	—	58	= 0 × \$18	= \$0
Independent Claims 7	—	7	= 0 × \$84	= \$0
If application has been amended to contain multiple dependent claim(s), then add			\$280	= \$0
Time Extension Fee				\$0
			TOTAL ADDITIONAL FEE FOR THIS AMENDMENT	\$0

(X) Response to Office Action in 5 pages.
(X) Return prepaid postcard.

- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.
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#11/Response
6/4/03
C. Paris
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Kim et al.

Appl. No. : 10/007,304

Filed : December 5, 2001

For : COPPER INTERCONNECT
STRUCTURE HAVING
STUFFED DIFFUSION BARRIER

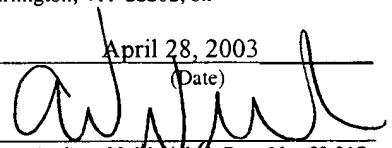
Examiner : RAO

Group Art Unit 2814

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April 28, 2003

(Date)


Andrew N. Menickel, Reg. No. 53,317

Response to Office Action

United States Patent and Trademark Office
P.O. Box 2327
Arlington, VA 22202

Dear Sir:

The present paper is submitted in response to the Office Action mailed on January 30, 2003. Applicants respectfully request reconsideration of the rejections in view of the remarks below.

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